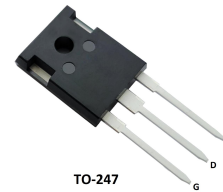
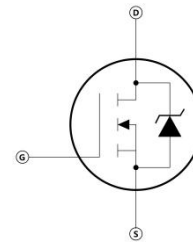


Features

- 100% avalanche tested
- Avalanche ruggedness
- Gate charge minimized
- Very low intrinsic capacitances
- High speed switching
- Very low on-resistance


General Description
Applications

- Welder
- UPS
- PV Inverter
- Switching applications


Electrical ratings

Absolute maximum ratings			
Parameter	Symbol	Value	Unit
Drain-source voltage ($V_{GS} = 0$)	V_{DS}	1500	V
Gate- source voltage	V_{GS}	± 30	
Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$	I_D	9	A
Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$		6	
Drain current (pulsed)		I_{DM}	
Total dissipation at $T_C = 25\text{ }^\circ\text{C}$	P_{TOT}	125	W
Operating junction temperature	T_J	-55 to 150	$^\circ\text{C}$
Storage temperature	T_{stg}		

Thermal data			
Parameter	Symbol	Value	Unit
Thermal resistance junction-case max	$R_{thj-case}$	2	$\text{W}/^\circ\text{C}$
Thermal resistance junction-ambient max	$R_{thj-amb}$	62	
Maximum lead temperature for soldering purpose	T_J	300	

Avalanche characteristics			
Parameter	Symbol	Max value	Unit

Avalanche current, repetitive or not-repetitive (pulse width limited by T_J max)	I_{AR}	8	A
Single pulse avalanche energy (starting $T_J = 25\text{ }^\circ\text{C}$, $I_D = I_{AR}$, $V_{DD} = 50\text{ V}$)	E_{AS}	800	mJ

Electrical Characteristics ($T_{vj} = 25^\circ\text{C}$ unless otherwise specified)

On /off states						
Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 1\text{ mA}$, $V_{GS} = 0$	1500			V
Zero gate voltage drain current ($V_{GS} = 0$)	I_{DSS}	$V_{DS} = \text{Max rating}$ $V_{DS} = \text{Max rating}$, $T_C = 125\text{ }^\circ\text{C}$			10 500	μA
Gate-body leakage current ($V_{DS} = 0$)	I_{GSS}	$V_{GS} = \pm 30\text{ V}$			± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$	3	4	5	V
Static drain-source on resistance	$R_{DS(on)}$	$V_{GS} = 10\text{ V}$, $I_D = 4\text{ A}$	-	2.2	3.2	Ω

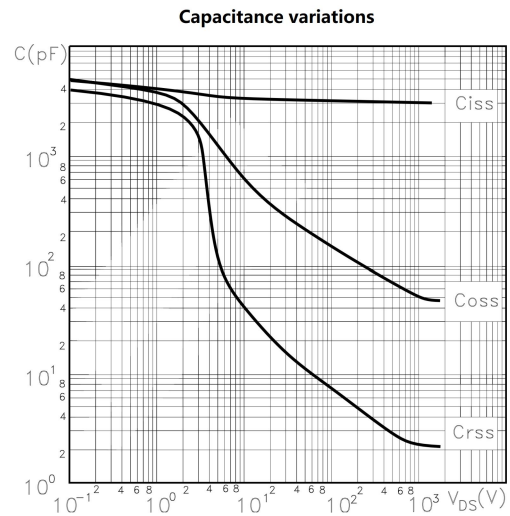
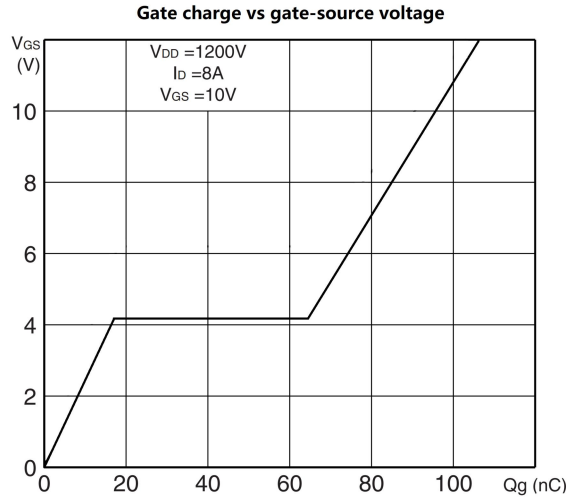
Dynamic						
Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Forward transconductance	g_{fs}	$V_{DS} = 15\text{ V}$, $I_D = 4$		7		S
Input capacitance	C_{iss}	$V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$, $V_{GS} = 0$		3150		pF
Output capacitance	C_{oss}			300		
Reverse transfer capacitance	C_{rss}			25		
Equivalent Output capacitance	$C_{oss\ eq.}$	$V_{GS} = 0$, $V_{DS} = 0$ to 1200 V		120		
Gate input resistance	R_g	$f = 1\text{ MHz}$ Gate DC Bias = 0 Test signal level = 20mV open drain		2.2		Ω
Total gate charge	Q_g	$V_{DD} = 1200\text{ V}$, $I_D = 8\text{ A}$ $V_{GS} = 10\text{ V}$		85		nC
Gate-source charge	Q_{gs}			14		
Gate-drain charge	Q_{gd}			48		

Switching times						
Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 750\text{ V}$, $I_D = 4\text{ A}$,		50		ns

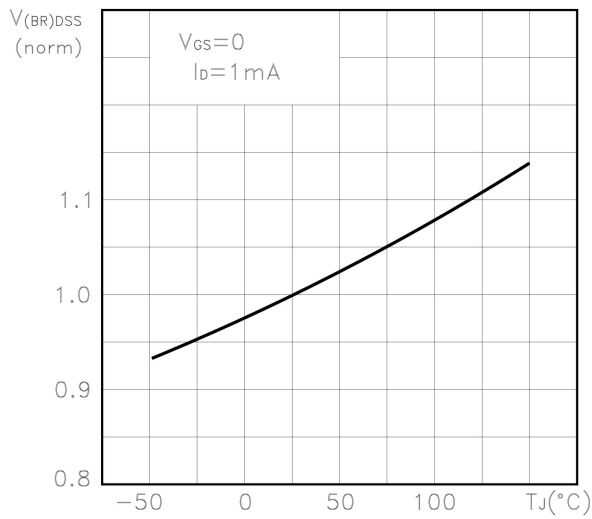
Rise time	t_r	$R_G = 4.7 \Omega, V_{GS} = 10 V$	16	
Turn-off-delay time	$t_{d(off)}$		100	
Fall time	t_f		80	

Source drain diode						
Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Source-drain current	I_{SD}			8		A
Source-drain current (pulsed)	I_{SDM}			40		
Forward on voltage	V_{SD}	$I_{SD} = 8 A, V_{GS} = 0$		1.5		V
Reverse recovery time	t_{rr}	$I_{SD} = 8A, di/dt=100A/\mu s$ $V_{DD} = 60 V$		950		ns
Reverse recovery charge	Q_{rr}			9		μC
Reverse recovery current	I_{RRM}			20		A
Reverse recovery time	t_{rr}	$S_D=8A, di/dt=100A/\mu s$ $V_{DD} = 60V T_J=150^\circ C$		900		ns
Reverse recovery charge	Q_{rr}			8.5		μC
Reverse recovery current	I_{RRM}			19		A

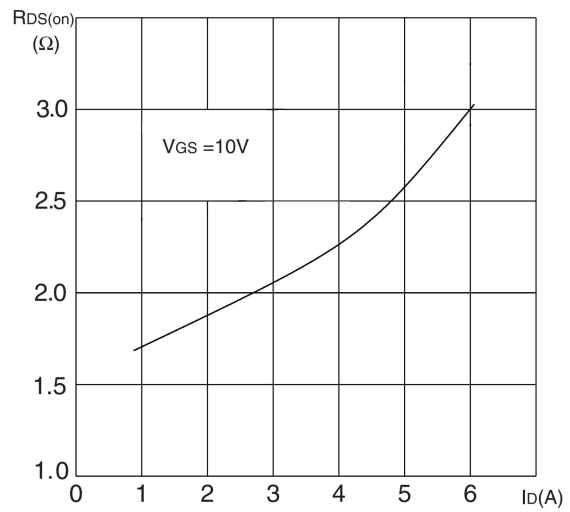
Electrical characteristics



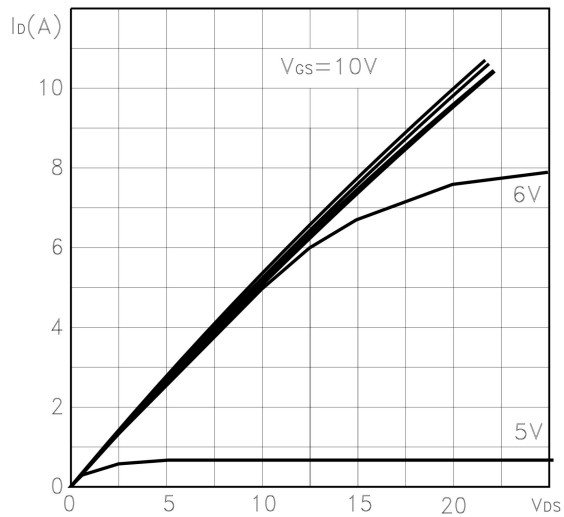
Normalized BVDSS vs temperature



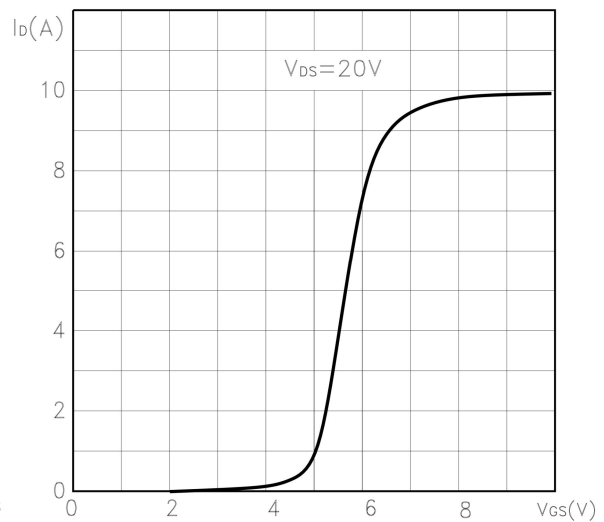
Static drain-source on resistance



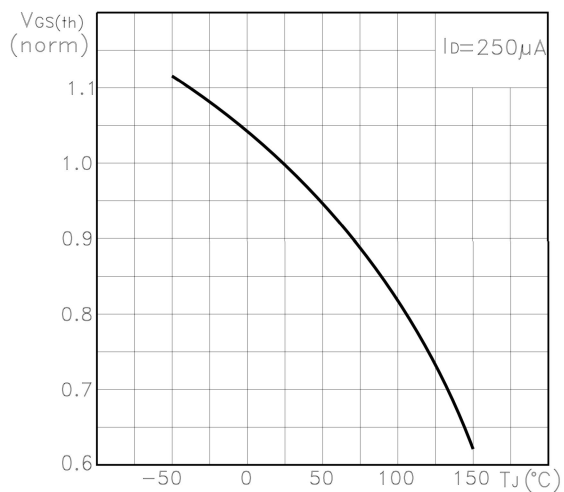
Output characteristics



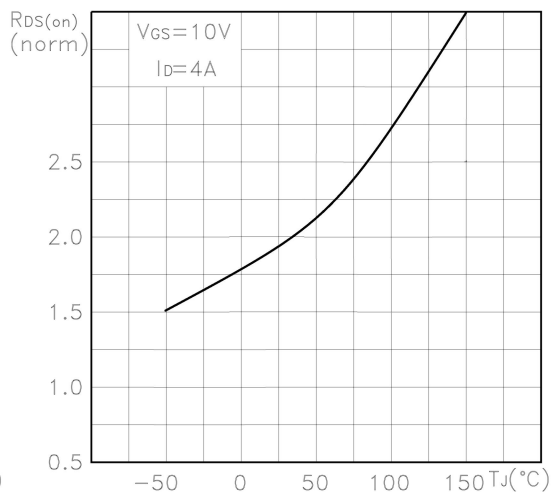
Transfer characteristics



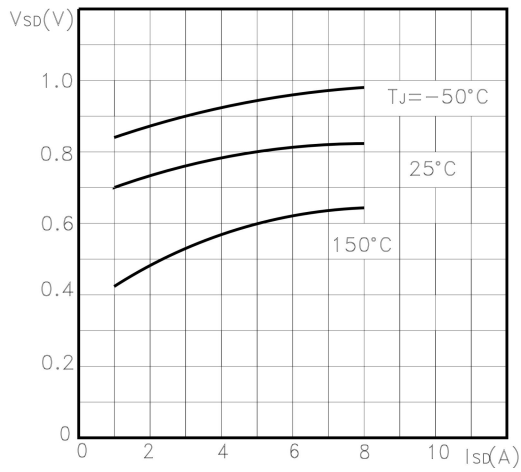
Normalized gate threshold voltage vs temperature



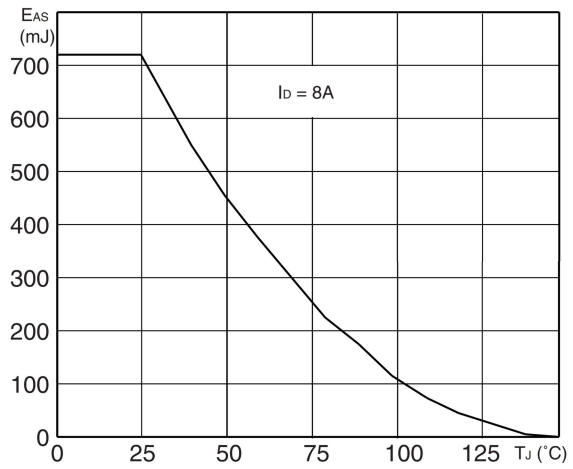
Normalized on resistance vs temperature



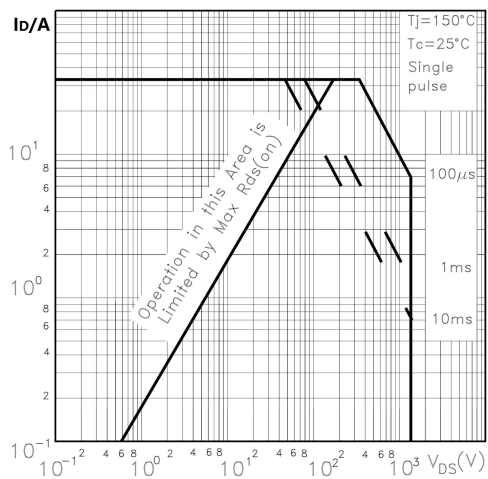
Source-drain diode forward characteristics



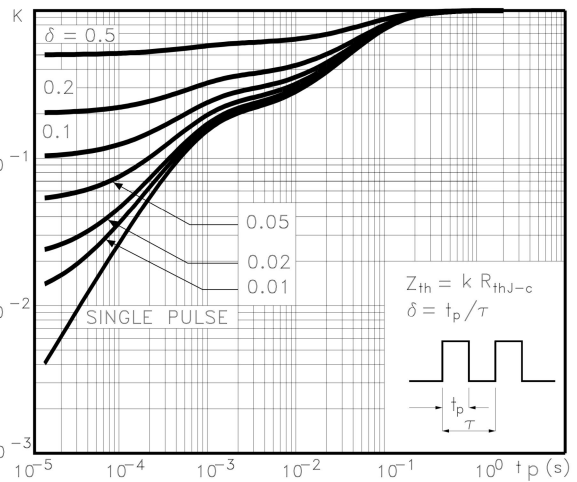
Maximum avalanche energy vs temperature



Safe operating area



Thermal impedance



Package outline dimension

